REISSUE APPLICATION DECLARATION BY THE INVENTOR

Docket Number (Optional) 1100.1138101

	1100.1138101				
As a below named inventor, I hereby declare that: My residence, mailing address and citizenship are stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is described and claimed in patent number 6,036,872, grantedMarch_14, 2000, and for which a reissue patent is sought on the invention entitled METHOD FOR MAKING A WAFER-PAIRHAVING SEALED CHAMBERS the specification of which					
is attached hereto. was filed on as reissue application nu and was amended on (If applicable)	umber/				
I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56. I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.)					
by reason of a defective specification or drawing.					
by reason of the patentee claiming more or less than he had the	ne right to claim in the patent.				
by reason of other errors.					
At least one error upon which reissue is based is described below. If the reissue is a broadening reissue, such must be stated with an explanation as to the nature of the broadening:					
I believe it was an error to limit all of the issued indep No. 6,036,872 to a first "silicon" wafer. My invention silicon" wafers. As noted in the present specification 6,036,872, column 4, lines 18-23), the wafers may be materials, and that the claims should not be limited to from silicon or any other material system.	should not be limited to n (see, U.S. Patent No. e made from any number of				
All errors which are being corrected in the present rei time of filing of this declaration arose without any dec the applicant.	ssue application up to the eptive intention on the part of				

PTO/SB/51 (02-01)
Approved for use through 01/31/2004. OMB 0651-0033
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(REISSUE APPLICATION DECLARATION BY THE INVENTOR, page 2)			Docket Number (Optional) 1100.1138101			
All errors corrected in this reissue application arose without any deceptive intention on the part of the applicant. As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the United States Patent and Trademark Office connected therewith.						
Name(s) Registration Number John G. Shudy, Jr. 31,214						
Brian N. Tufte	38,638					
Correspondence A	ddress: Direct all communications about	t the application to				
Type Customer Number here			Code Label here			
Firm or Individual Name						
Address						
Address						
City		State	Zip			
Country						
Telephone		Fax				
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine and imprisonment, or both, under 18 U.S.C. 1001, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this declaration is directed.						
Full name of sole or first inventor (given name, family name) R. Andrew Wood						
Inventor's signature	ROWA	Date (0/31/01				
Residence	Bloomington, Minnesota	Citizenship US				
Mailing Address 150 East Mission Lane, Bloomington, Minnesota 55420						
Full name of second joint inventor (given name, family name) Jeffrey A. Ridley						
Inventor's signature	Jelly a Vidle	Date 10-31-01				
Residence	Burnsvile Minnesota	Citizenship US				
Mailing Address 13021 Highpoint Curve, Burnsville, Minnesota 55337						
Full name of third joint inventor (given name, family name)						
Robert E. Higashi Inventor's signature Date 15/21/01						
	1841) 2 The o	Date 10/31/01				
Residence	Shorewood, Minnesota	Citizenship US				
Mailing Address 20220 Manor Road, Shorewood, Minnesota 55331						
Additional joint inventors are named on separately numbered sheets attached hereto.						

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REISSUE APPLICATION: CONSENT OF ASSIGNEE;

Docket Number (Optional)

STATEMENT OF NON-ASSIGNMENT		1100.1138101 (H16-17400)				
This is part of the application for a reissue patent based on the o	riginal pa	tent identified belo	w.			
Name of Patentee(s) Ronald A. Wood et al.						
Patent Number 6,036,872	Date Pa	tent Issued	March 14, 2000			
Title of Invention METHOD FOR MAKING A WAFER-PAIR HAVING SEALED CHAMBERS						
1. Filed herein is a statement under 37 CFR 3.73(b).	(Form PT	O/SB/96)				
2. — Ownership of the patent is in the inventor(s), and no assignment of the patent is in effect.						
One of boxes 1 or 2 above must be checked. If multiple assignees, complete this form for each assignee. If box 2 is checked, skip the next entry and go directly to "Name of Assignee". The written consent of all assignees and inventors owning an undivided interest in the original patent is included in this application for reissue.						
The assignee(s) owning an undivided interest in said original patent is/are Honeywell Inc. and the assignee(s) consents to the accompanying application for reissue.						
Name of assignee/inventor (if not assigned)						
Honeywell Inc.						
Signature / Serve	Date	1/01				
Typed or printed name and title of person signing for assignee (if	assigned	l)				
David Hoiriis, Associate General Counsel and Chief Patent Counsel						

Burden Hour Statement: This form is estimated to take 0.1 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.